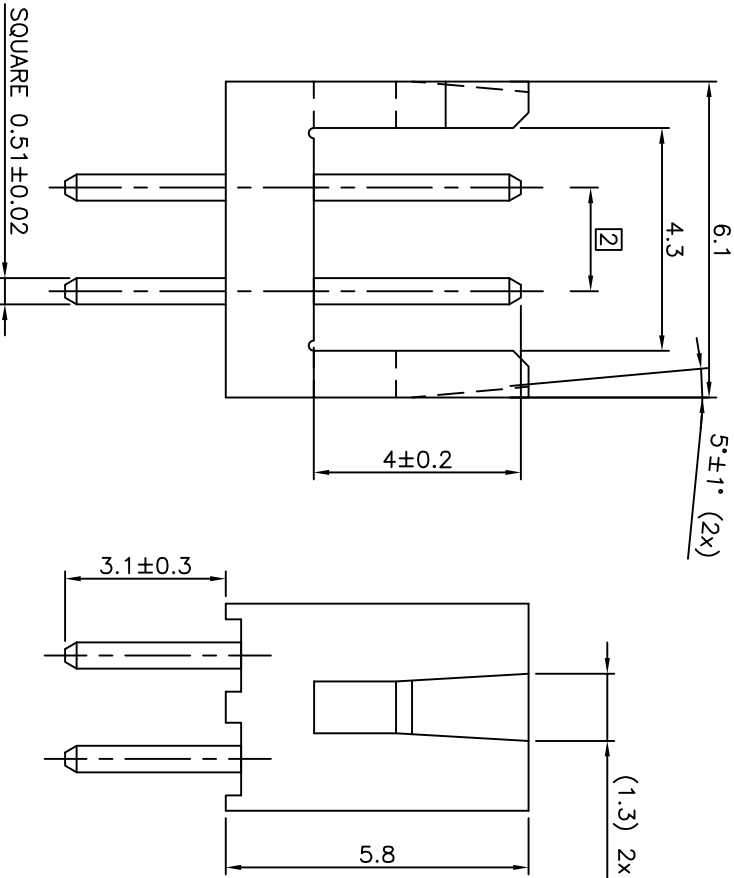
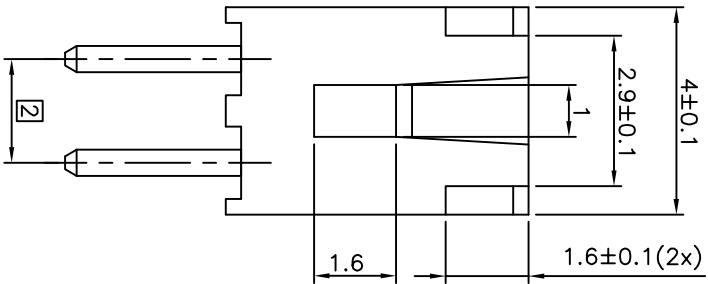
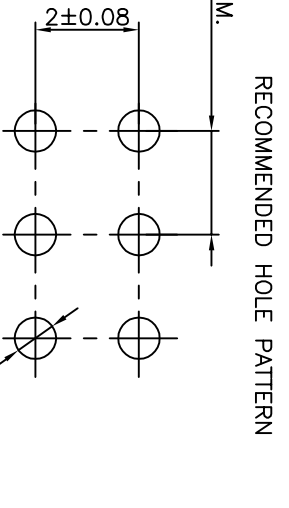


98415-104LF

RoHS COMPATIBLE, SEE NOTES 5



NOTES:

- 1 - HOUSING MATERIAL: LCP COLOR CREAM.
- 2 - PLATING : 0.76µm GOLD/GXT OVER 1.27µm Ni MIN
- 3 - TERMINAL MATERIAL: COPPER ALLOY
- 4 - STANDARD PACKAGING IN POLYBAGS
- 5. RoHS COMPATIBLE PRODUCT SPECIFICATIONS
 - a - MANUFACTURING PROCESS COMPATIBILITY
 - THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C ±5°C SOLDER BATH TEMPERATURE FOR 5 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.6mm MIN THICK CIRCUIT BOARD.
 - b - LABELLING:
 - MEETS PACKAGING SPECS AS PER GS-14-920
 - c - THIS PRODUCT MEETS EUROPEAN DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-47-0004



Form: A3

mat'l. code		surface		projection	product	
SEE NOTE		ISO 1302	ISO 406	ISO 101	family	MINITEK HEADER
ltr	ecn no	dr	date	tolerances unless otherwise specified	title	MINITEK
C	F05-0268	J00	05.10.06	±0.2	MINITEK	2x2
D	F08-0210	LWU	08.07.05	linear	scale 10:1	
E	F08-0148	EIA	08.04.15	±2°	dwg no	98415
F	B-19190	LWU	14.10.24	linear	sheet 1 of 1	size A3
					eng'g	J.M.C
					dppd	02.07.29
sheet	revision					
index	sheet					